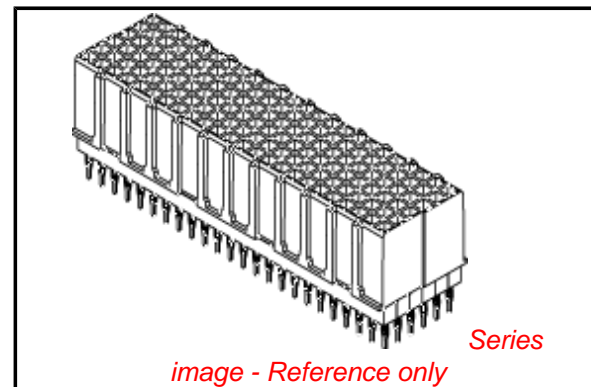


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**Part Number:** **0737801253**  
**Status:** **Active**  
**Overview:** [hdm](#)  
**Description:** 2.00mm (.079") Pitch HDM® Board-to-Board Daughtercard Receptacle, Vertical, Signal Module, 144 Circuits, Mounted Height 13.00mm (.512"), Pin Length 3.50mm (.138"), Solder Tail

**Documents:**

[3D Model](#)  
[Drawing \(PDF\)](#)  
[Test Summary \(PDF\)](#)  
[Product Specification PS-73780-999 \(PDF\)](#)  
[RoHS Certificate of Compliance \(PDF\)](#)



**General**

Product Family	Backplane Connectors
Series	<a href="#">73780</a>
Application	Daughtercard, Mezzanine
Comments	Solder Tail
Component Type	PCB Receptacle
Overview	<a href="#">hdm</a>
Product Name	HDM®
Style	N/A

**Physical**

Circuits (Loaded)	144
Circuits (maximum)	144
Color - Resin	Black
Durability (mating cycles max)	250
First Mate / Last Break	No
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Copper-Nickel-Tin
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Number of Columns	24
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
PC Tail Length (in)	0.138 In
PC Tail Length (mm)	3.50 mm
PCB Locator	No
PCB Retention	None
PCB Thickness Recommended (in)	0.063 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.079 In
Pitch - Mating Interface (mm)	2.00 mm
Pitch - Term. Interface (in)	0.079 In
Pitch - Term. Interface (mm)	2.00 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	100
Plating min: Termination (µm)	2.5
Polarized to PCB	No
Stackable	Yes
Surface Mount Compatible (SMC)	Yes

**EU RoHS**

**ELV and RoHS  
Compliant**  
**REACH SVHC  
Contains SVHC: No**  
**Halogen-Free  
Status**  
**Not Reviewed**

**China RoHS**



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For a multiple part number RoHS Certificate of Compliance, [click here](#)

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**Search Parts in this Series**

[73780Series](#)

**Mates With**

HDM® Board-to-Board Backplane Header [73642](#) , [73643](#) , [73644](#) , [73942](#) , [73943](#) , [73944](#) , [74349](#) , [74428](#). HDM® Board-to-Board Stacking Header [73769](#) , [73770](#) , [73782](#) , [73783](#) , [73771](#)

Temperature Range - Operating -55°C to +105°C  
Termination Interface: Style Through Hole

### **Electrical**

Current - Maximum per Contact 15A, 1A  
Data Rate 1.0 Gbps  
Real Signals (per 25mm) 75  
Shielded No  
Voltage - Maximum 250V AC

### **Solder Process Data**

Duration at Max. Process Temperature (seconds) 5  
Lead-free Process Capability Wave Capable (TH only)  
Max. Cycles at Max. Process Temperature 1  
Process Temperature max. C 260

### **Material Info**

### **Reference - Drawing Numbers**

Product Specification PS-73780-999  
Sales Drawing SD-73780-004

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